# **ON Semiconductor**

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ON Semiconductor®

# FCB20N60-F085

# N-Channel MOSFET 600V, 20A, 198m $\Omega$

#### **Features**

- Typ  $r_{DS(on)}$  = 173m $\Omega$  at  $V_{GS}$  = 10V,  $I_D$  = 20A
- Typ  $Q_{q(tot)}$  = 72nC at  $V_{GS}$  = 10V,  $I_D$  = 20A
- UIS Capability
- RoHS Compliant
- Qualified to AEC Q101

#### Description

SuperFET<sup>TM</sup> is ON Semiconductor's proprietary new generation of high voltage MOSFETs utilizing an advanced charge balance mechanism for outstanding low on-resistance and

lower gate charge performance.

This advanced technology has been tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy.

Consequently, SuperFET is suitable for various automotive DC/DC power conversion.

### **Applications**

- Automotive On Board Charger
- Automotive DC/DC converter for HEV

## MOSFET Maximum Ratings T<sub>J</sub> = 25°C unless otherwise noted

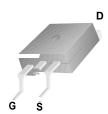
Symbol	Parameter		Ratings	Units
$V_{DSS}$	Drain to Source Voltage		600	V
$V_{GS}$	Gate to Source Voltage		±30	V
	Drain Current - Continuous (V <sub>GS</sub> =10) (Note 1)	T <sub>C</sub> = 25°C	20	۸
I <sub>D</sub>	Pulsed Drain Current	T <sub>C</sub> = 25°C	See Figure4	A
E <sub>AS</sub>	Single Pulse Avalanche Energy	(Note 2)	480	mJ
В	Power Dissipation		341	W
$P_{D}$	Derate above 25°C		2.3	W/°C
$T_J$ , $T_{STG}$	Operating and Storage Temperature		-55 to + 150	°C
$R_{\theta JC}$	Thermal Resistance Junction to Case		0.44	°C/W
$R_{\theta JA}$	Maximum Thermal Resistance Junction to Ambient	(Note 3)	43	°C/W

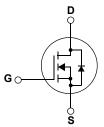
#### **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FCB20N60	FCB20N60-F085	TO-263AB	330mm	24mm	800 units

#### Notes:

- 1: Current is limited by bondwire configuration.
- 2: Starting  $T_J = 25^{\circ}$ C, L = 15mH,  $I_{AS} = 8$ A,  $V_{DD} = 100$ V during inductor charging and  $V_{DD} = 0$ V during time in avalanche
- 3:  $R_{\theta JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins.  $R_{\theta JC}$  is guaranteed by design while  $R_{\theta JA}$  is determined by the user's board design. The maximum rating presented here is based on mounting on a 1 in<sup>2</sup> pad of 2oz copper.







Units

nΑ

Max

±100

Тур

# **Electrical Characteristics** $T_J = 25^{\circ}C$ unless otherwise noted

**Parameter** 

Gate to Source Leakage Current

Off Cha	racteristics						
B <sub>VDSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250μA, V	<sub>GS</sub> = 0V	600	-	-	V
	Drain to Source Leakage Current	V <sub>DS</sub> =600V,	$T_{J} = 25^{\circ}C$	-	-	1	μΑ
IDSS	Drain to Source Leakage Current	$V_{GS} = 0V$	$T_J = 150^{\circ}C(Note 4)$	-	-	1	mA

 $V_{GS} = \pm 30V$ 

**Test Conditions** 

Min

## **On Characteristics**

Symbol

 $I_{GSS}$ 

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 250\mu A$		3.0	4.0	5.0	V
r <sub>DS(on)</sub> Drain to Source On Resistance	Drain to Source On Registance	I <sub>D</sub> = 20A,	$T_{J} = 25^{\circ}C$	-	173	198	$m\Omega$
	Dialii to Source On Resistance	V <sub>GS</sub> = 10V	$T_J = 150^{\circ}C(Note 4)$	-	471	570	mΩ

# **Dynamic Characteristics**

C <sub>iss</sub>	Input Capacitance	)/ OF)/ )/	0) (	-	2710	3080	pF
C <sub>oss</sub>	Output Capacitance	$V_{DS}$ = 25V, $V_{GS}$ = 0V, f = 1MHz		-	1350	1665	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			-	86	150	pF
$R_g$	Gate Resistance	f = 1MHz		-	1	-	Ω
$Q_{g(ToT)}$	Total Gate Charge at 10V	V <sub>GS</sub> = 0 to 10V	V <sub>DD</sub> = 300V	-	72	102	nC
$Q_{g(th)}$	Threshold Gate Charge	$V_{GS} = 0$ to 2V	I <sub>D</sub> = 20A	-	5	8.6	nC
Q <sub>gs</sub>	Gate to Source Gate Charge		_	-	15	-	nC
$Q_{gd}$	Gate to Drain "Miller" Charge			-	31	-	nC

# **Switching Characteristics**

t <sub>on</sub>	Turn-On Time	$V_{DD}$ = 300V, $I_{D}$ = 20A, $V_{GS}$ = 10V, $R_{G}$ = 25 $\Omega$	-	-	166	ns
t <sub>d(on)</sub>	Turn-On Delay Time		-	44	-	ns
t <sub>r</sub>	Rise Time		-	60	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		-	208	-	ns
t <sub>f</sub>	Fall Time		-	43	-	ns
t <sub>off</sub>	Turn-Off Time		-	-	400	ns

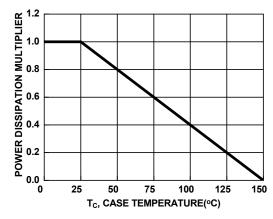
#### **Drain-Source Diode Characteristics**

$V_{SD}$	Source to Drain Diode Voltage	$I_{SD} = 20A, V_{GS} = 0V$	-	1	1.4	V
T <sub>rr</sub>	Reverse Recovery Time	$I_F = 20A$ , $dI_{SD}/dt = 100A/\mu s$ ,	-	486	632	ns
$Q_{rr}$	Reverse Recovery Charge	V <sub>DD</sub> =480V	-	10	13	μС

#### Notes

4: The maximum value is specified by design at  $T_J$  = 150°C. Product is not tested to this condition in production.

# **Typical Characteristics**



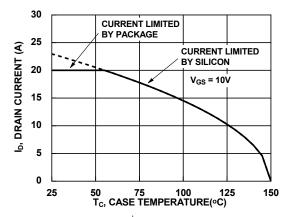
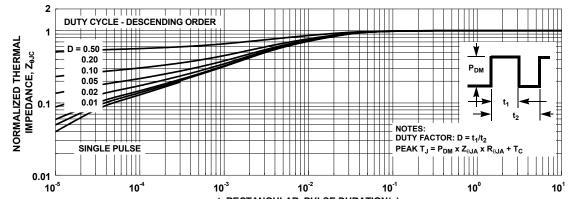


Figure 1. Normalized Power Dissipation vs Case Temperature

Figure 2. Maximum Continuous Drain Current vs Case Temperature



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Figure 3. Normalized Maximum Transient Thermal Impedance

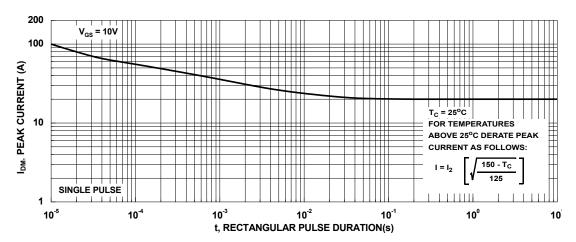


Figure 4. Peak Current Capability

# **Typical Characteristics**

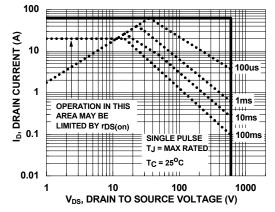


Figure 5. Forward Bias Safe Operating Area

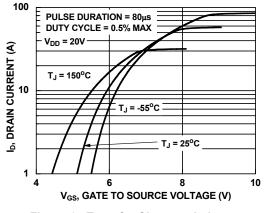


Figure 6. Transfer Characteristics

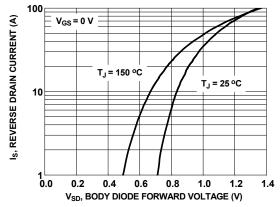


Figure 7. Forward Diode Characteristics

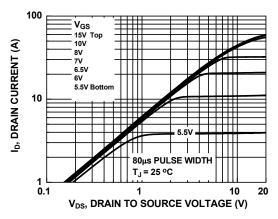


Figure 8. Saturation Characteristics

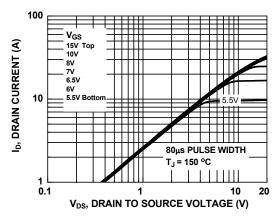


Figure 9. Saturation Characteristics

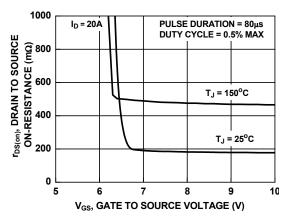


Figure 10. Rdson vs Gate Voltage

# **Typical Characteristics**

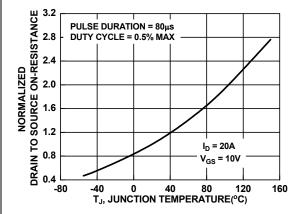


Figure 11. Normalized Rdson vs Junction Temperature

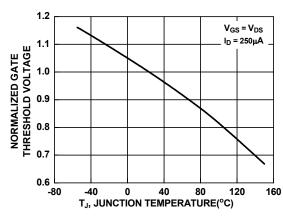


Figure 12. Normalized Gate Threshold Voltage vs
Temperature

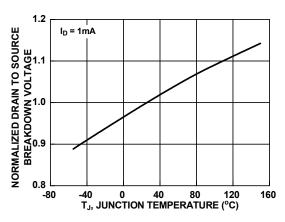


Figure 13. Normalized Drain to Source Breakdown Voltage vs Junction Temperature

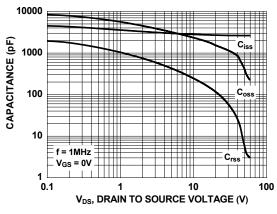


Figure 14. Capacitance vs Drain to Source Voltage

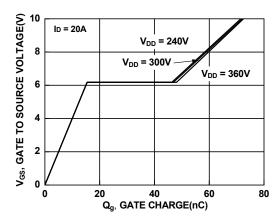


Figure 15. Gate Charge vs Gate to Source Voltage

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